



# **SL-T4437PDC020-L55 PHOTO Diode**

**DATA SHEET** 

 SPEC. NO.
 : SZ20101502

 DATE
 : 2020/10/15

 REV.
 : A/0

Approved By: Checked By: Prepared By:

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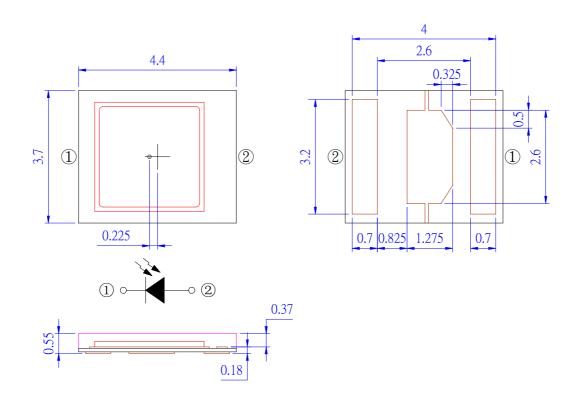
## **Features**

- ◆ Pb free product—RoHS compliant
- ♦ High Photo Sensitivity
- ♦ Reliable and rugged
- ♦ Long life solid state reliability
- ♦ Sensitivity angle: 135°

# Application

- ♦ Health Monitoring
- ♦ Photo Detector

# Package Dimension



Part NO.	Chip Material	Lens Color
SL-T4437PDC020-L55	Silicon	Water Clear

### **Notes:**

- 1. All dimensions are in millimeters.
- 2. Tolerance is  $\pm 0.10$ mm unless otherwise noted.
- 3. Specifications are subject to change without notice.

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### Absolute Maximum Ratings at Ta=25℃

Parameter	Maximum Rating	Unit	
Power Dissipation	150 mW		
Reverse Voltage	30 V		
Electrostatic Discharge (HBM)*2	8000 V		
Moisture Sensitivity Level*1	4		
Operating Temperature	-40°C ~+85°C		
Storage Temperature Range	-40°C∼+100°C		
IR Reflow Temperature	260°C for 10 Seconds MAX.		
Hand Soldering Condition	300°C for 3 Seconds MAX.		

#### 1. Storage and operating:

- (1). Storage requirements before vacuum bag opened: Temperature<30°C, Humidity<65%RH;
- (2). Check air leakage and vacuum bag damage before opened. If there is any issue found, check the humidity indicator card immediately after bag opened:
  - a. If color changes on "10% circle" of the humidity indicator card only and not the circles of 20% and above, components can be used without additional handling;
  - b. If color changes on both 10% and 20% circles but not the circles of 30% and above, components must be dehumidified according to the conditions of bullet (5);
  - c. If color changes on 10%, 20%, and 30% circle or above, the product should be returned to the supplier for high temperature dehumidification;
- (3). After bag opened, manual soldering or reflow process must follow the following requirements:
  - a. Complete soldering / reflow within 72 hours;
  - b. Requirements of working environment: Temperature < 30°C, Humidity < 60%RH;
- (4). If the working condition is outside (3)a requirement, the components must be dehumidified according to the conditions of bullet (5);
- (5). Low temperature dehumidification: temperature 60±5 °C, at least 24 hours;
- (6). Shelf life: 180 days. If it's over 180 days from the production date on the package label, the components must be dehumidified according to the condition of bullet (5). If customer is unable to dehumidify, return components to LIGHT for dehumidification.

### 2. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.





### Electrical Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Reverse Light Current	$I_L$		40		μΑ	$V_{R}=5V$ $Ee=1 \text{mW/cm}^{2}$ $\lambda p=940 \text{nm}$
Reverse Light Current	$I_L$		35		μA	$V_{R}=5V$ $Ee=1 \text{mW/cm}^{2}$ $\lambda p=660 \text{nm}$
Reverse Light Current	$I_L$		25		μA	$V_R=5V$ $Ee=1mW/cm^2$ $\lambda d=525nm$
Reverse Dark Current	$I_D$			10	nA	$V_R=10V$ $Ee=0mW/cm^2$
Reverse Voltage	$V_{(R)}$	30			V	$I_R=100\mu A$
Forward Voltage	$V_{\mathrm{F}}$			1.3	V	I <sub>F</sub> =10mA
Viewing Angle(X)	$2\theta_{1/2}$		135		Deg.	(Note 1)
Viewing Angle(Y)	$2\theta_{1/2}$		135		Deg.	(Note 1)
Rise Time/Fall Time	tr/tf		30		ns	V <sub>R</sub> =10V RL=1kΩ
Total Capacitance	$C_{\mathrm{T}}$		12		pF	$V_R=5V$ $Ee=0mW/cm^2$ $f=1.0MHz$

### **Note:**

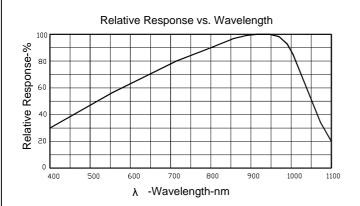
- 1.  $\theta_{1/2}$  is the off-axis angle at which the Reverse Light Current is half the axial Reverse Light Current.
- 2. The  $I_L$  guarantee should be added  $\pm 15\%$  tolerance.

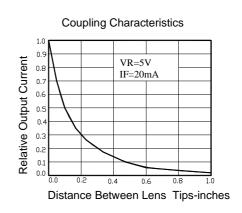
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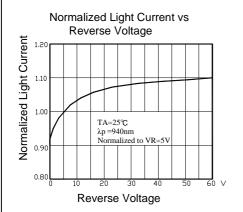


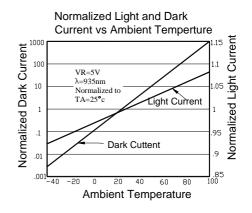


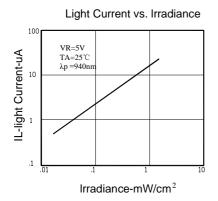
# Typical Electrical / Optical Characteristics Curves (25℃ Ambient Temperature Unless Otherwise Noted)

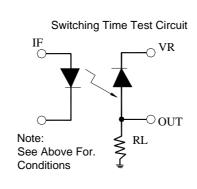


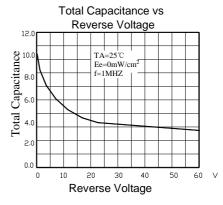


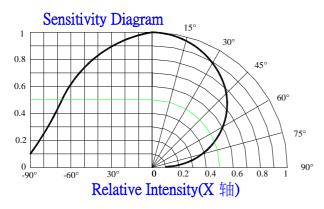


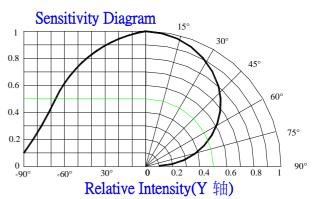












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# Reverse Light Current Bin Code (V<sub>R</sub>=5V, Ee=1mW/cm<sup>2</sup>, λp=940nm)

BIN CODE	Min.(μA)	Max.(μA)
33	31	37
34	37	44
35	44	53

**NOTE:** The  $I_L$  guarantee should be added  $\pm 15\%$  tolerance.





# **Label Explanation**

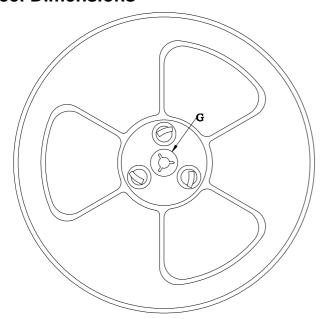
### LIGHT Universal Label

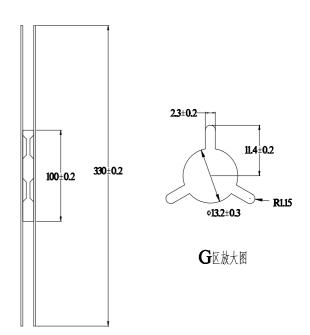


### **Customer Defined Label**



### **Reel Dimensions**





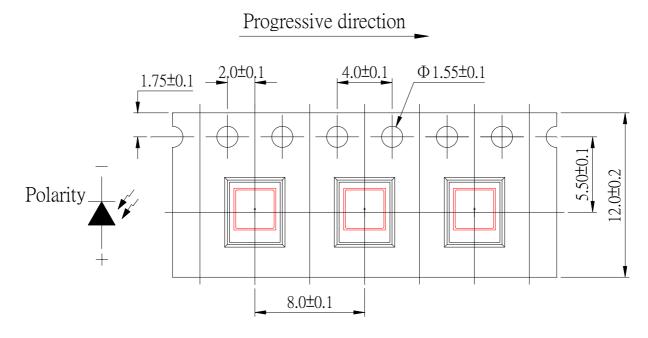
**Note:** Tolerance unless mentioned is  $\pm 0.2$ mm; Unit = mm

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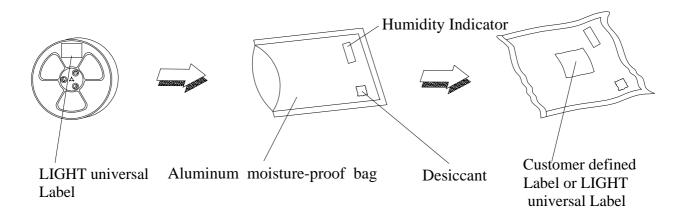


## **Carrier Tape Specifications**



**Note:** Tolerance unless mentioned is  $\pm 0.1$ mm; Unit = mm

# Moisture Resistant Packaging

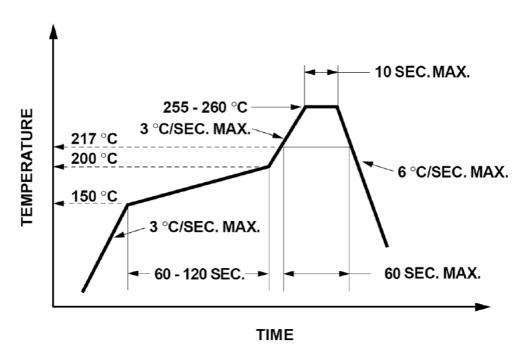


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### Suggest IR Reflow Condition For Lead Free



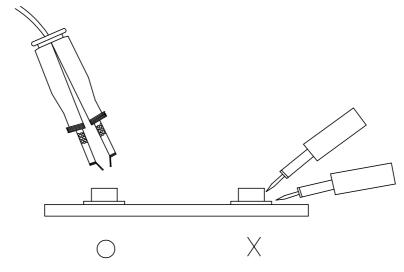
- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.

### Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 300°C for 3 seconds.
- 2. The hand solder should be done only once.

### Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



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